

TOSHIBA**TD62083APA**

TOSHIBA BIPOLAR DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TD62083APA**8CH DARLINGTON SINK DRIVER**

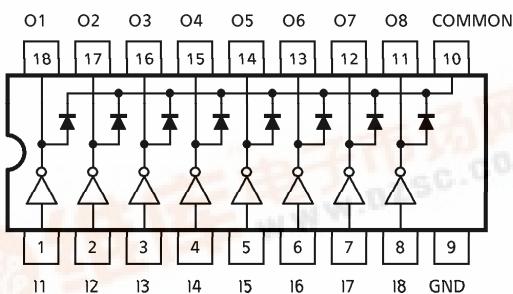
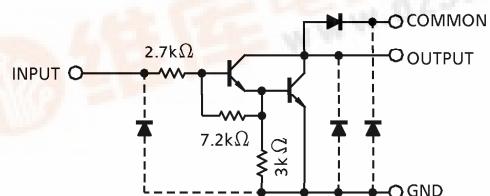
The TD62083APA is high-voltage, high-current darlington drivers comprised of eight NPN darlington pairs.

All units feature integral clamp diodes for switching inductive loads.

Applications include relay, hammer, lamp and display (LED) drivers.

FEATURES

- Output current (single output) 500mA MAX.
- High sustaining voltage output 50V MIN.
- Output clamp diodes
- Inputs resistor : $R_{IN} = 2.7k\Omega$ Typ.
- Inputs compatible with TTL, 5V CMOS
- Package Type-AP : DIP-18pin

PIN CONNECTION (TOP VIEW)**SCHEMATICS (EACH DRIVER)**

(Note) The input and output parasitic diodes cannot be used as clamp diodes.

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MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Output Sustaining Voltage	V _{CE} (SUS)	- 0.5~50	V
Output Current	I _{OUT}	500	mA / ch
Input Voltage	V _{IN}	- 0.5~30	V
Clamp Diode Reverse Voltage	V _R	50	V
Clamp Diode Forward Current	I _F	500	mA
Power Dissipation	P _D	1.47	W
Operating Temperature	T _{opr}	- 40~85	°C
Storage Temperature	T _{stg}	- 55~150	°C

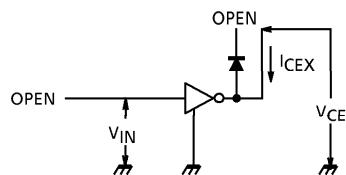
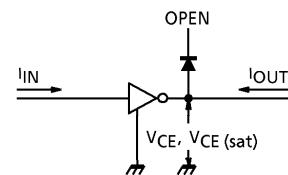
RECOMMENDED OPERATING CONDITIONS (Ta = - 40~85°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Output Sustaining Voltage	V _{CE} (SUS)		0	—	50	V
Output Current	I _{OUT}	DC 1 Circuit, Ta = 25°C	0	—	400	mA / ch
		T _{pw} = 25ms, 8 Circuits	0	—	347	
		T _a = 85°C, T _j = 120°C	0	—	123	
Input Voltage	V _{IN}		0	—	30	V
Input Voltage	Output On	V _{IN} (ON)	2.5	—	30	V
	Output Off	V _{IN} (OFF)	0	—	0.5	
Clamp Diode Reverse Voltage	V _R		—	—	50	V
Clamp Diode Forward Current	I _F		—	—	400	mA
Power Dissipation	P _D		—	—	0.52	W

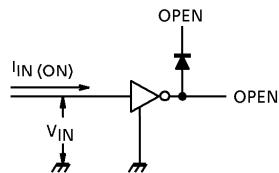
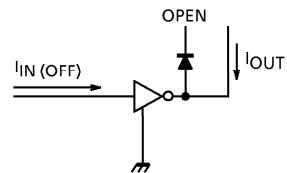
ELECTRICAL CHARACTERISTICS ($T_a = 25^\circ\text{C}$)

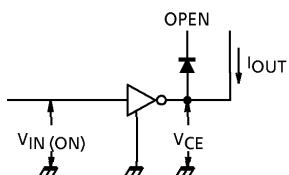
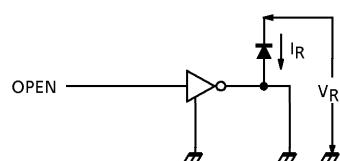
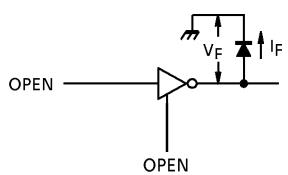
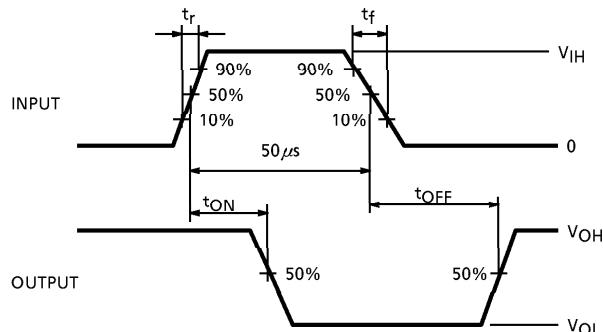
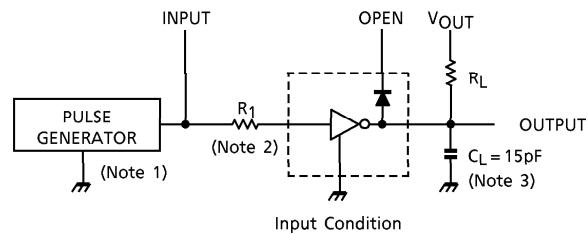
CHARACTERISTIC	SYMBOL	TEST CIR-CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Output Leakage Current	I_{CEX}	1	$V_{CE} = 50\text{V}, T_a = 25^\circ\text{C}$	—	—	50	μA
			$V_{CE} = 50\text{V}, T_a = 85^\circ\text{C}$	—	—	100	
Collector-Emitter Saturation Voltage	$V_{CE(\text{sat})}$	2	$I_{OUT} = 350\text{mA}, I_{IN} = 500\mu\text{A}$	—	1.3	1.6	V
			$I_{OUT} = 200\text{mA}, I_{IN} = 350\mu\text{A}$	—	1.1	1.3	
			$I_{OUT} = 100\text{mA}, I_{IN} = 250\mu\text{A}$	—	0.9	1.1	
DC Current Transfer Ratio	h_{FE}	2	$V_{CE} = 2\text{V}, I_{OUT} = 350\text{mA}$	1000	—	—	
Input Current	Output On Output Off	$I_{IN(\text{ON})}$ $I_{IN(\text{OFF})}$	$V_{IN} = 3.85\text{V}$	—	0.93	1.35	mA
			$I_{OUT} = 500\mu\text{A}, T_a = 85^\circ\text{C}$	50	65	—	μA
Input Voltage	Output On	$V_{IN(\text{ON})}$	$V_{CE} = 2\text{V}, I_{OUT} = 250\text{mA}$	—	—	2.7	V
			$V_{CE} = 2\text{V}, I_{OUT} = 300\text{mA}$	—	—	3.0	
Clamp Diode Reverse Current	I_R	6	$V_R = 50\text{V}, T_a = 25^\circ\text{C}$	—	—	50	μA
			$V_R = 50\text{V}, T_a = 85^\circ\text{C}$	—	—	100	
Clamp Diode Forward Voltage	V_F	7	$I_F = 350\text{mA}$	—	—	2.0	V
Input Capacitance	C_{IN}	—		—	15	—	pF
Turn-On Delay	t_{ON}	8	$V_{OUT} = 50\text{V}, R_L = 125\Omega, C_L = 15\text{pF}$	—	0.1	—	μs
Turn-Off Delay	t_{OFF}	8		—	0.2	—	

TEST CIRCUIT

1. I_{CEX} 2. $V_{CE(\text{sat})}, h_{FE}$ 

$$h_{FE} = \frac{I_{OUT}}{I_{IN}}$$

3. $I_{IN(\text{ON})}$ 4. $I_{IN(\text{OFF})}$ 

5. $V_{IN(ON)}$ 6. I_R 7. V_F 8. t_{ON} , t_{OFF} 

(Note 1) Pulse width $50\mu s$, duty cycle 10%
Output impedance 50Ω , $t_r \leq 5ns$, $t_f \leq 10ns$

(Note 2) See below

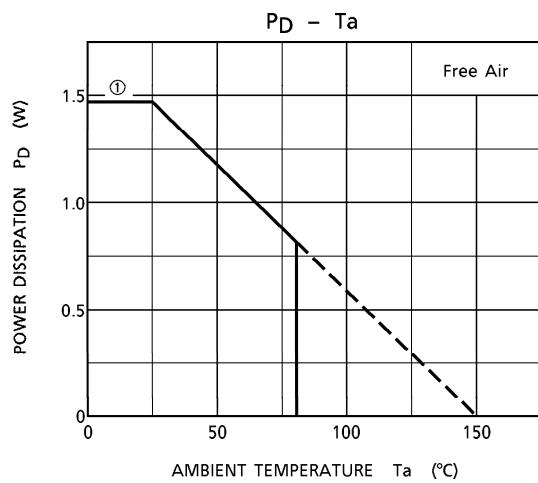
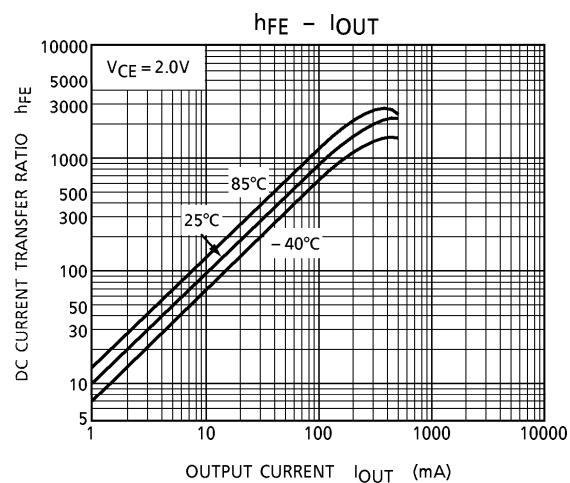
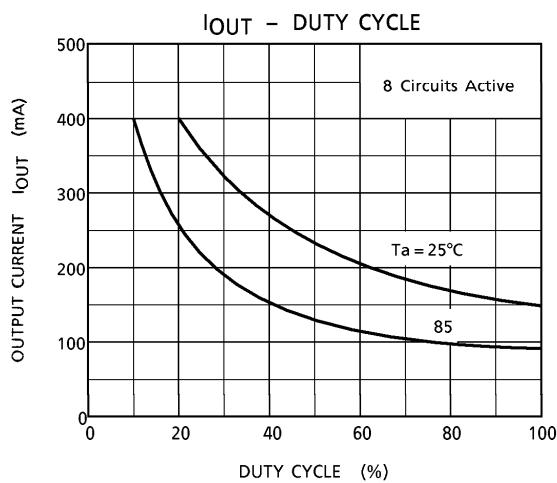
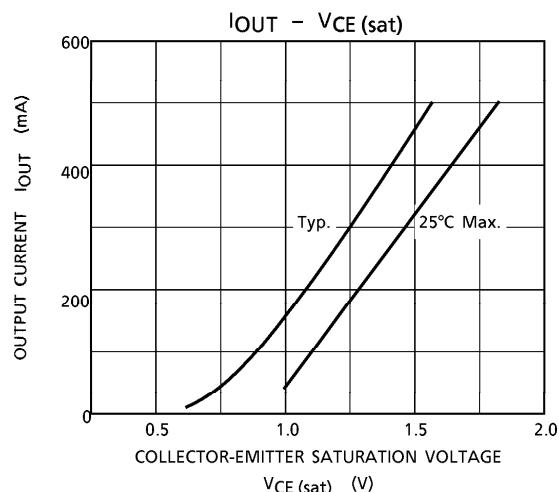
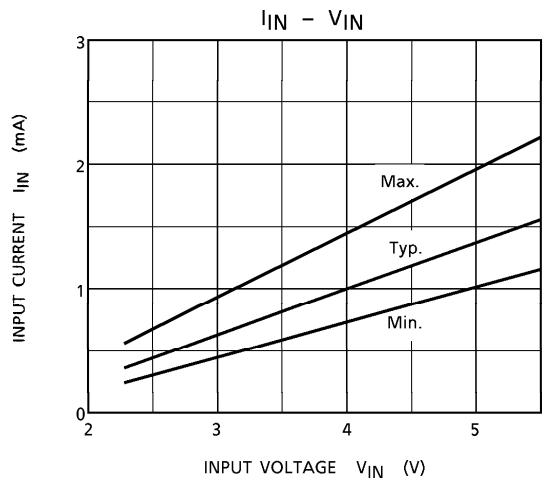
INPUT CONDITION

TYPE NUMBER	R_{IN}	V_{IH}
TD62083APA	0	3V

(Note 3) C_L includes probe and jig capacitance.

PRECAUTIONS for USING

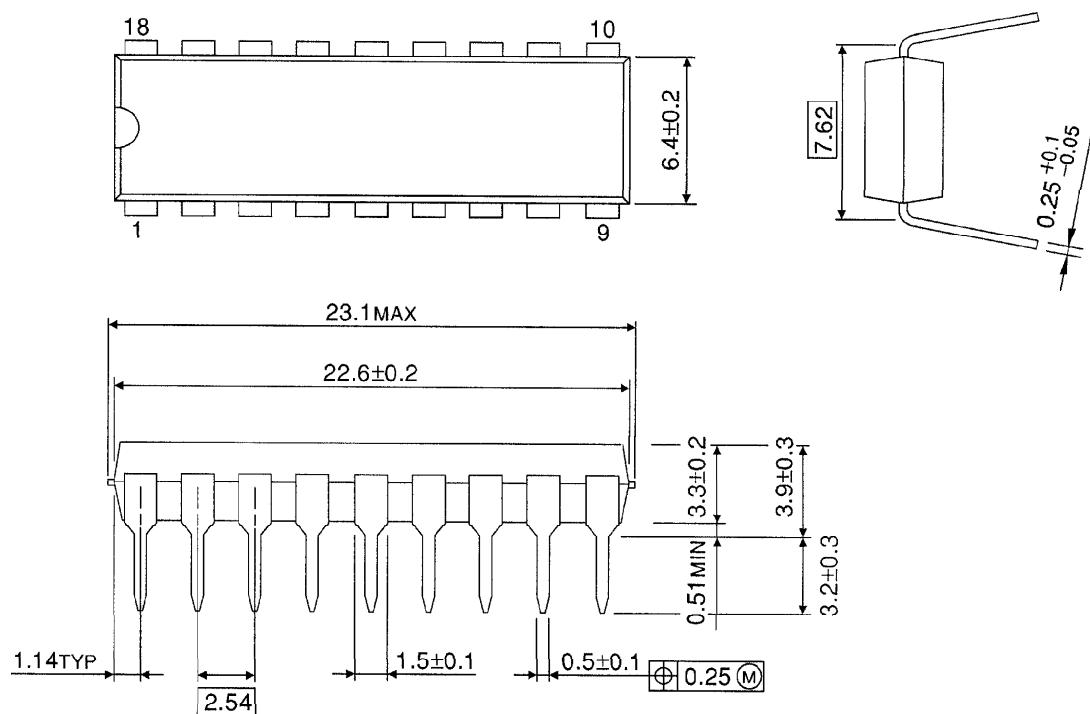
Utmost care is necessary in the design of the output line, COMMON and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.



OUTLINE DRAWING

DIP18-P-300-2.54F

Unit : mm



Weight : 1.478g (Typ.)